

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE
REQUEST FOR FILING APPLICATION UNDER 37 CFR 1.53(b)
WITHOUT FILING FEE OR EXECUTED INVENTOR'S DECLARATION

Assistant Commissioner for Patents
Washington, DC 20231

Atty. Dkt. 925-177

Date: February 7, 2001

Sir:

JC971 U.S. PTO
09/778045
02/07/01

This is a request for filing a new PATENT APPLICATION under Rule 53(b) entitled:
SEMICONDUCTOR LIGHT-EMITTING DEVICE AND MANUFACTURING METHOD THEREFOR

without a filing fee and/or without an executed inventor's oath/declaration.

This application is made by the below identified inventor(s). Attached hereto are the following papers:

- ☒ An abstract together with
42 pages of specification and claims including
14 numbered claims and also attached is/are
24 sheets of accompanying drawings.
☒ This application is based on the following prior foreign application(s):

Application No.	Country
2000-029030	JAPAN
2000-372776	JAPAN

Filing Date
7 February 2000
7 December 2000

respectively, the entire content of which is hereby incorporated by reference in this application, and priority is hereby claimed therefrom.

- ☐ This application is based on the following prior provisional application(s):
- | Application No. | Filing Date |
|-----------------|-------------|
|-----------------|-------------|

respectively, the entire content of which is hereby incorporated by reference in this application, and priority is hereby claimed therefrom.

- ☒ Certified copy/ies of foreign applications attached.
This application is a ☐ continuation/☐ division/☐ continuation-in-part of application Serial No. , filed
Please amend the specification by inserting before the first line: --This application is a ☐ continuation/☐ division/
☐ continuation-in-part of application Serial No. , filed , the entire content of which is hereby incorporated by
reference in this application.--

Please amend the specification by inserting before the first line: --This is a continuation of PCT application No.
, filed , the entire content of which is hereby incorporated by reference in this application.--

Please amend the specification by inserting before the first line: --This application claims the benefit of U.S.
Provisional Application No. , filed , the entire content of which is hereby incorporated by reference in this
application.--

Preliminary amendment to claims (attached hereto), to be entered before calculation of the fee.

Also attached: ☒ Information Disclosure Statement ; ☐ Non-Publication Request; ☐ Other:

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☒ See attached sheet(s) for additional inventor(s) information!!

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